

WHAT IS CLAIMED IS:

1. A method for controlling a micro-electromechanical system (MEMS), said
2 method comprising:

4 providing a rotatable mirror with an optical sensor that is in electrical
communication with said rotatable mirror via an associated electrode;

6 supplying electrical potential to said optical sensor, wherein said optical
sensor is configured to provide a variable range of voltages to said rotatable mirror;

8 directing an optical control beam onto said optical sensor, wherein said optical
sensor determines optical characteristics of said optical control beam;

10 responsively supplying voltage to said rotatable mirror, wherein an amount
of said supplied voltage is based on the determined optical characteristics of said
optical control beam; and

12 rotating said rotatable mirror about a primary axis in response to said supplied
voltage to said rotatable mirror.

2. The method according to claim 1, said method further comprising:

2 controlling an angle of rotation of said rotatable mirror about said primary axis
by modifying the optical characteristics of said optical control beam.

3. The method according to claim 1, said method further comprising:

2 controlling an angle of rotation of said rotatable mirror about said primary axis
by modifying an optical wavelength of said optical control beam.

4. The method according to claim 1, said method further comprising:

2 controlling an angle of rotation of said rotatable mirror about said primary axis
by modifying a light intensity of said optical control beam.

5. The method according to claim 1, said method further comprising:

2 providing said rotatable mirror with a plurality of optical sensors that are in
4 electrical communication with said rotatable mirror via separate electrodes, wherein
a first and second optical sensor, of said plurality of optical sensors, are associated
with rotating said rotatable mirror about respective primary and secondary axes;

6 supplying electrical potential to each of said plurality of optical sensors,
8 wherein each of said plurality of optical sensors are configured to provide a variable
range of voltages to said rotatable mirror;

10 directing a first optical control beam onto said first optical sensor, and
12 directing a second optical control beam onto said second optical sensor, wherein
said first and second optical sensors respectively determine optical characteristics
of said first and second optical control beams;

14 responsively supplying voltage to said rotatable mirror, wherein an amount
of said supplied voltage is based on the respectively determined optical
characteristics of said first and second optical control beams; and

16 rotating said rotatable mirror about said primary and secondary axes in
response to voltage respectively supplied by said first and second optical sensors.

6. The method according to claim 5, said method further comprising:

2 controlling respective angles of rotation of said rotatable mirror about said
primary and secondary axes by modifying the respective optical characteristics of
4 said first and second optical control beams.

7. The method according to claim 5, wherein said primary and secondary axes
2 are perpendicular.

8. The method according to claim 1, wherein said micro-electromechanical
2 system (MEMS) is used in an optical cross connect switch.

9. The method according to claim 1, wherein said optical control beam is
2 generated by a light source selected from the group consisting of a light emitting
diode (LED), an optical fiber, a laser, and a vertical cavity surface emitting laser
4 (VCSEL).

10. The method according to claim 1, said method further comprising:

2 controlling an angle of rotation of said rotatable mirror about said primary axis
by modifying at least one optical characteristic of said optical control beam, wherein
4 said at least one optical characteristic is selected from the group consisting of
optical wavelength, light intensity, position, polarization, and duty cycle.

11. A method for controlling a micro-electromechanical system (MEMS), said

2 method comprising:

3 providing a plurality of rotatable mirrors to form a MEMS array, wherein each

4 of said plurality of rotatable mirrors includes an associated optical sensor;

5 supplying electrical potential to each of said plurality of optical sensors,

6 wherein each one of said plurality of optical sensors is configured to provide a

7 variable range of voltages to an associated rotatable mirror;

8 directing an optical control beam onto a first optical sensor, which is one of

9 said plurality of optical sensors, wherein said first optical sensor determines optical

10 characteristics of said optical control beam;

11 responsively supplying voltage to a rotatable mirror that is associated with

12 said first optical sensor, wherein an amount of said supplied voltage is based on the

13 determined optical characteristics of said optical control beam; and

14 rotating said rotatable mirror that is associated with said first optical sensor

about a primary axis in response to said supplied voltage.

12. The method according to claim 11, said method further comprising:

2 controlling an angle of rotation of said rotatable mirror that is associated with

3 said first optical sensor about said primary axis by modifying the optical

4 characteristics of said optical control beam.

13. The method according to claim 11, said method further comprising:
2 supplying electrical potential to each of said plurality of optical sensors via a
common electrical lead.
14. The method according to claim 11, said method further comprising:
2 supplying electrical potential to each of said plurality of optical sensors via a
number of electrical leads, wherein the number of electrical leads is less than a
4 number of said plurality of optical sensors.
15. The method according to claim 11, said method further comprising:
2 supplying electrical potential to each of said plurality of optical sensors via a
number of electrical leads, wherein the number of electrical leads is less than a
4 number of said plurality of rotatable mirrors that form said MEMS array.

16. A method for controlling a micro-electromechanical system (MEMS), said

2 method comprising:

providing a plurality of rotatable mirrors having a plurality of associated
4 optical sensors, wherein a first and second optical sensor of each of said plurality
of associated optical sensors enable rotation of an associated rotatable mirror about
6 respective primary and secondary axes;

supplying electrical potential to each of said plurality of associated optical
8 sensors, wherein each of said plurality of associated optical sensors are configured
to provide a variable range of voltages to an associated rotatable mirror;

directing first and second optical control beams onto respective first and
second optical sensors, wherein said first and second optical sensors respectively
determine optical characteristics of said first and second optical control beams;

responsively supplying voltage to a rotatable mirror that is associated with
14 said first and second optical sensors, wherein an amount of said supplied voltage
is based on the respectively determined optical characteristics of said first and
16 second optical control beams; and

rotating said rotatable mirror that is associated with said first and second
18 optical sensors about a primary and secondary axes in response to voltage
respectively supplied by said first and second optical sensors.

17. The method according to claim 16, said method further comprising:

2 controlling respective angles of rotation about said primary and secondary

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axes by modifying the respective optical characteristics of said first and second
4 optical control beams.

18. The method according to claim 16, said method further comprising:
2 supplying electrical potential to each of said plurality of associated optical
sensors via a common electrical lead.

19. The method according to claim 16, said method further comprising:
2 supplying electrical potential to each of said plurality of associated optical
sensors via a number of electrical leads, wherein the number of electrical leads is
4 less than a number of said plurality of associated optical sensors.

20. The method according to claim 16, said method further comprising:
2 supplying electrical potential to each of said plurality of associated optical
sensors via a number of electrical leads, wherein the number of electrical leads is
4 less than a number of said plurality of rotatable mirrors.

21. The method according to claim 16, wherein said micro-electromechanical
2 system (MEMS) is used in an optical cross connect switch.

22. An optically controlled micro-electromechanical system (MEMS), said MEMS

2 comprising:

a rotatable mirror having an optical sensor that is in electrical communication

4 with said rotatable mirror via an associated electrode;

6 an electrical lead that supplies electrical potential to said optical sensor;

8 an optical controller for directing an optical control beam onto said optical
sensor, wherein said optical sensor determines optical characteristics of said optical
control beam; and

10 a voltage controller that is configured with said optical sensor, wherein said
determined optical characteristics of said optical control beam, causing said
rotatable mirror to rotate about out a primary axis in response to voltage supplied
by said voltage controller.

23. The micro-electromechanical system (MEMS) according to claim 22, wherein

2 said optical controller modifies the optical characteristics of said optical control
beam to control an angle of rotation of said rotatable mirror about said primary axis.

24. The micro-electromechanical system (MEMS) according to claim 22, wherein

2 said optical controller modifies an optical wavelength of said optical control beam
to control an angle of rotation of said rotatable mirror about said primary axis.

25. The micro-electromechanical system (MEMS) according to claim 22, wherein
2 said optical controller modifies a light intensity of said optical control beam to
control an angle of rotation of said rotatable mirror about said primary axis.

26. The micro-electromechanical system (MEMS) according to claim 22, wherein
2 said optical control beam is generated by a light source selected from the group
consisting of a light emitting diode (LED), an optical fiber, a laser, and a vertical
4 cavity surface emitting laser (VCSEL).

27. The micro-electromechanical system (MEMS) according to claim 22, wherein
2 said optical controller modifies at least one optical characteristic of said optical
control beam to control an angle of rotation of said rotatable mirror about said
primary axis, wherein said at least one optical characteristic is selected from the
4 group consisting of optical wavelength, light intensity, position, polarization, and
5 duty cycle.

28. An optically controlled micro-electromechanical system (MEMS), said MEMS

2 comprising:

a rotatable mirror having a plurality of optical sensors that are in electrical

4 communication with said rotatable mirror via separate electrodes, wherein a first and

second optical sensor, of said plurality of optical sensors, are associated with

6 rotating said rotatable mirror about respective primary and secondary axes;

at least one electrical lead that supplies electrical potential to each of said

8 plurality of optical sensors;

an optical controller for directing first and second optical control beams onto
10 respective first and second optical sensors, wherein said first and second optical
sensors respectively determine optical characteristics of said first and second optical
12 control beams; and

14 a voltage controller that is configured with said optical sensor, wherein said
voltage controller responsively supplies voltage to said rotatable mirror based on the
16 respectively determined optical characteristics of said first and second optical
control beams, causing said rotatable mirror to rotate about said primary and
secondary axes.

29. The micro-electromechanical system (MEMS) according to claim 28, wherein

2 said optical controller modifies the optical characteristics of said first and second
optical control beams to control respective angles of rotation of said rotatable mirror

4 about said primary and secondary axes.

30. An optically controlled micro-electromechanical system (MEMS), said MEMS
6 comprising:

a plurality of rotatable mirrors having a plurality of associated optical sensors,
8 wherein a first and second optical sensor, of each of said plurality of associated
optical sensors, enable rotation of an associated rotatable mirror about respective
10 primary and secondary axes;

at least one power lead that supplies electrical potential to each of said
12 plurality of associated optical sensors;

an optical controller for directing first and second optical control beams onto
14 respective first and second optical sensors, wherein said first and second optical
sensors respectively determine optical characteristics of said first and second optical
control beams; and

18 a separate voltage controller that is configured with each of said plurality of
associated optical sensors, wherein said separate voltage controller responsively
supplies voltage to an associated rotatable mirror based on the respectively
20 determined optical characteristics of said first and second optical control beams,
causing said rotatable mirror to rotate about said primary and secondary axes.

31. The micro-electromechanical system (MEMS) according to claim 30, wherein
2 said optical controller modifies the optical characteristics of said first and second
optical control beams to control respective angles of rotation of said rotatable mirror
4 about said primary and secondary axes.

32. The micro-electromechanical system (MEMS) according to claim 30, wherein
2 said electrical potential is supplied to each of said plurality of associated optical
sensors via a common electrical lead.

33. The micro-electromechanical system (MEMS) according to claim 30, wherein
2 said electrical potential is supplied to each of said plurality of associated optical
sensors via a number of electrical leads, wherein the number of electrical leads is
4 less than a number of said plurality of associated optical sensors.

34. The micro-electromechanical system (MEMS) according to claim 30, wherein
2 said electrical potential is supplied to each of said plurality of associated optical
sensors via a number of electrical leads, wherein the number of electrical leads is
4 less than a number of said plurality of rotatable mirrors.

35. An optical cross connect switch utilizing an optically controlled micro-electromechanical system (MEMS), said switch comprising:

a fiber optic switch beam generating element that generates a communication

light beam;

a fiber optic switch beam receiving element that receives said communication

light beam from said fiber optic switch beam generating element at one of an array
of output fibers;

a MEMS device for directing said communication light beam from said fiber
optic switch beam generating element to a particular output fiber of said beam
receiving element, wherein said MEMS device comprises:

a rotatable mirror having an optical sensor that is in electrical
communication with said rotatable mirror via an associated electrode;

an electrical lead that supplies electrical potential to said optical sensor;

an optical controller for directing an optical control beam onto said
optical sensor, wherein said optical sensor determines optical characteristics
of said optical control beam; and

a voltage controller that is configured with said optical sensor, wherein
said voltage controller responsively supplies voltage to said rotatable mirror
based on the determined optical characteristics of said optical control beam,
causing said rotatable mirror to rotate about out a primary axis in response
to said supplied voltage;

wherein said optical controller controls which particular output fiber

that said communication beam is directed by modifying the optical characteristics of said optical control beam.